

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of

Tetuo YUKI, *et al.*

Serial No.: T/B/A

Group Art Unit: T/B/A

Filed: Herewith

Examiner: T/B/A

For: METHOD FOR PULVERIZING TO FINE POWDER

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Assistant Commissioner for Patents  
Box PCT  
Washington, D.C. 20231

**PRELIMINARY AMENDMENT**

Sir:

Prior to the calculation of the filing fee and examination of the above-referenced new United States Patent Application, please amend the present Application as follows.

**IN THE CLAIMS:**

Please cancel claims 1-6 without prejudice, and replace them with new claims 7-13 as provided herein.

AI 7. A method of micronizing a (E)-4-[2-[2-[N-acetyl-N-(4-methoxybenzenesulfonyl)amino]phenyl]ethenyl]pyridine 1-oxide compound comprising the step of pulverizing the compound with an open-circuit pulverizing type mill.

8. The micronizing method of claim 7 wherein said open-circuit pulverizing type mill is either a high-speed rotary impact mill or a pneumatic mill.